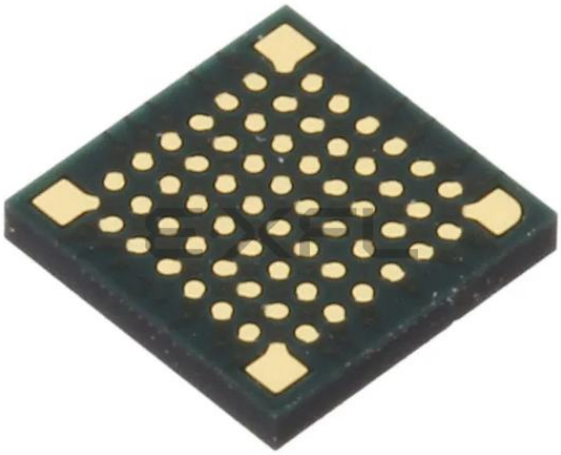

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	RX
Core Size	32-Bit Single-Core
Speed	32MHz
Connectivity	I²C, SCI, SPI, USB OTG
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	46
Program Memory Size	64KB (64K x 8)
Program Memory Type	FLASH
EEPROM Size	8K x 8
RAM Size	10K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 14x12b; D/A 2x8b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	64-WFLGA
Supplier Device Package	64-FLGA (5x5)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f51113adlf-ua

1.3 Block Diagram

Figure 1.2 shows a block diagram.

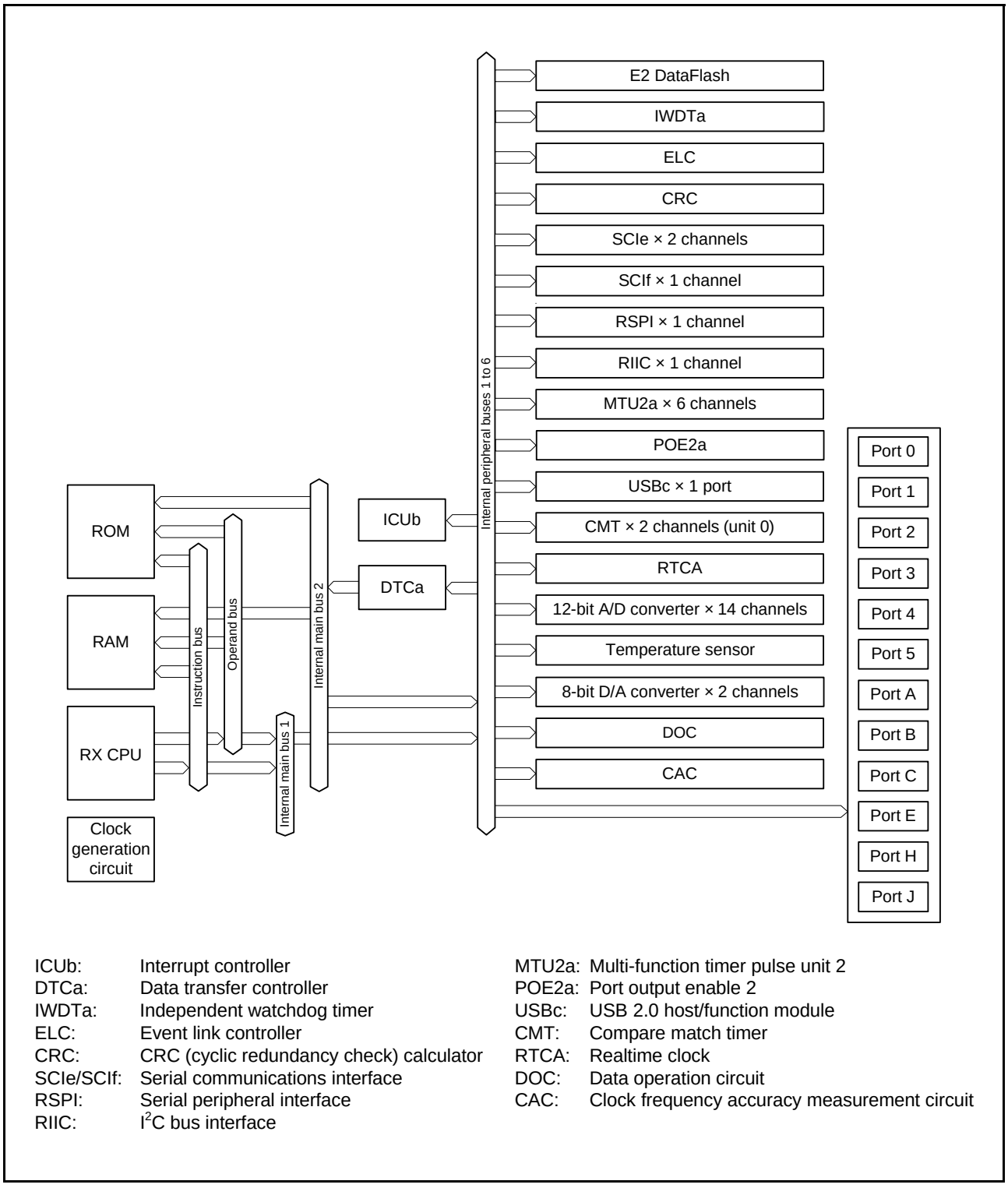
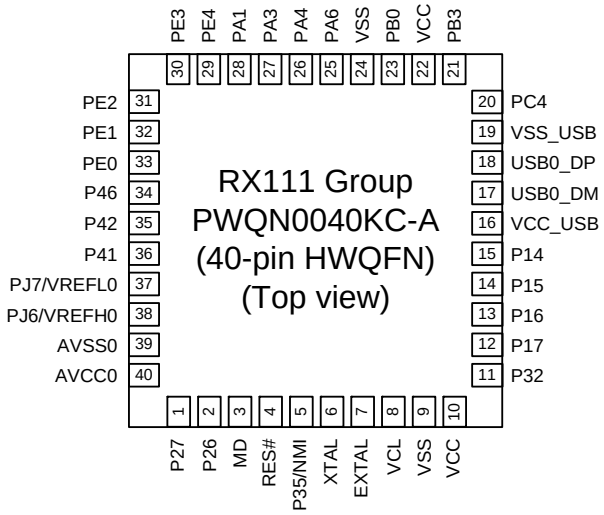


Figure 1.2 Block Diagram

Table 1.4 Pin Functions (3/3)

Classifications	Pin Name	I/O	Description
USB 2.0 host/ function module	USB0_DP	I/O	D+ I/O pin of the USB on-chip transceiver.
	USB0_DM	I/O	D- I/O pin of the USB on-chip transceiver.
	USB0_VBUS	Input	USB cable connection monitor pin.
	USB0_EXICEN	Output	Low-power control signal for the OTG chip.
	USB0_VBUSEN	Output	VBUS (5 V) supply enable signal for the OTG chip.
	USB0_OVRCURA, USB0_OVRCURB	Input	External overcurrent detection pins.
	USB0_ID	Input	Mini-AB connector ID input pin during operation in OTG mode.
12-bit A/D converter	AN000 to AN004, AN006, AN008 to AN015	Input	Input pins for the analog signals to be processed by the A/D converter.
	ADTRG0#	Input	Input pin for the external trigger signals that start the A/D conversion.
D/A converter	DA0, DA1	Output	Output pins for the analog signals to be processed by the D/A converter.
I/O ports	P03, P05	I/O	2-bit input/output pins.
	P14 to P17	I/O	4-bit input/output pins.
	P26, P27	I/O	2-bit input/output pins.
	P30 to P32, P35	I/O	4-bit input/output pins (P35 input pin).
	P40 to P44, P46	I/O	6-bit input/output pins.
	P54, P55	I/O	2-bit input/output pins.
	PA0, PA1, PA3, PA4, PA6	I/O	5-bit input/output pins.
	PB0, PB1, PB3, PB5 to PB7	I/O	6-bit input/output pins.
	PC0 to PC7	I/O	8-bit input/output pins.
	PE0 to PE7	I/O	8-bit input/output pins.
	PH7	Input	1-bit input pin.
	PJ6, PJ7	I/O	2-bit input/output pins.

Note 1. For external clock input.



Note: • This figure indicates the power supply pins and I/O port pins.
For the pin configuration, see the table “List of Pins and Pin Functions (40-Pin HWQFN)”.
Note: • It is recommended that the exposed die pad of HWQFN should be connected to VSS.

Figure 1.6 Pin Assignments of the 40-Pin HWQFN

Table 1.5 List of Pins and Pin Functions (64-Pin LFQFP/LQFP) (1/2)

Pin No.	Power Supply, Clock, System Control	I/O Port	Timers (MTU, POE, RTC)	Communication (SCIe, SCIf, RSPI, RIIC, USB)	Others
1		P03			DA0
2		P27	MTIOC2B	SCK1/SCK12	IRQ3/CMPA2/ CACREF/ADTRG0#
3		P26	MTIOC2A	TXD1/SMOSI1/SSDA1/USB0_VBUSEN	
4		P30	MTIOC4B/POE8#	RXD1/SMISO1/SSCL1	IRQ0
5		P31	MTIOC4D	CTS1#/RTS1#/SS1#	IRQ1
6	MD				FINED
7	RES#				
8	XCOUT				
9	XCIN	PH7			
10	UPSEL	P35			NMI
11	XTAL				
12	EXTAL				
13	VCL				
14	VSS				
15	VCC				
16		P32	MTIOC0C/RTCOUT		IRQ2
17		P17	MTIOC0C/MTIOC3A/ MTIOC3B/POE8#	SCK1/MISOA/SDA0/RXD12/RXDX12/ SMISO12/SSCL12	IRQ7
18		P16	MTIOC3C/MTIOC3D/ RTCOUT	TXD1/SMOSI1/SSDA1/MOSIA/SCL0/ USB0_VBUS/USB0_VBUSEN/ USB0_OVRCURB	IRQ6/ADTRG0#
19		P15	MTIOC0B/MTCLKB	RXD1/SMISO1/SSCL1/RSPCKA	IRQ5/CLKOUT
20	UB#	P14	MTIOC0A/MTIOC3A/ MTCLKA	CTS1#/RTS1#/SS1#/SSLA0/TXD12/ TXDX12/SIOX12/SMOSI12/SSDA12/ USB0_OVRCURA	IRQ4
21	VCC_USB				
22				USB0_DM	
23				USB0_DP	
24	VSS_USB				
25		P55	MTIOC4D		
26		P54	MTIOC4B		
27		PC7	MTIOC3A/MTCLKB	TXD1/SMOSI1/SSDA1/MISOA/ USB0_OVRCURB	CACREF
28		PC6	MTIOC3C/MTCLKA	RXD1/SMISO1/SSCL1/MOSIA/ USB0_EXICEN	
29		PC5	MTIOC3B/MTCLKD	SCK1/RSPCKA/USB0_ID	
30		PC4	MTIOC3D/MTCLKC/POE0#	SCK5/SSLA0/USB0_VBUS*1/ USB0_VBUSEN	IRQ2/CLKOUT
31		PC3	MTIOC4D	TXD5/SMOSI5/SSDA5	
32		PC2	MTIOC4B	RXD5/SMISO5/SSCL5/SSLA3	
33		PB7/PC1	MTIOC3B		
34		PB6/PC0	MTIOC3D		
35		PB5	MTIOC2A/MTIOC1B/POE1#		
36		PB3	MTIOC0A/MTIOC3B/ MTIOC4A/POE3#	USB0_OVRCURA	
37		PB1	MTIOC0C/MTIOC4C		IRQ4
38	VCC				
39		PB0	MTIC5W/MTIOC0C/ RTCOUT	SCL0/RSPCKA	IRQ2/ADTRG0#
40	VSS				
41		PA6	MTIC5V/MTCLKB/MTIOC2A/ POE2#	CTS5#/RTS5#/SS5#/SDA0/MOSIA	IRQ3

Table 1.7 List of Pins and Pin Functions (48-Pin LFQFP/HWQFN) (2/2)

Pin No.	Power Supply, Clock, System Control	I/O Port	Timers (MTU, POE, RTC)	Communication (SCIe, SCIf, RSPI, RIIC, USB)	Others
39		PE0	MTIOC2A/POE3#	SCK12	IRQ0/AN008
40		PE7			IRQ7/AN015
41		P46*2			AN006
42		P42*2			AN002
43		P41*2			AN001
44	VREFL0	PJ7*2			
45		P40*2			AN000
46	VREFH0	PJ6*2			
47	AVSS0				
48	AVCC0				

Note 1. Not 5 V tolerant.
Note 2. The power source of the I/O buffer for these pins is AVCC0.

3. Address Space

3.1 Address Space

This MCU has a 4-Gbyte address space, consisting of the range of addresses from 0000 0000h to FFFF FFFFh. That is, linear access to an address space of up to 4 Gbytes is possible, and this contains both program and data areas.
Figure 3.1 shows the memory map.

Table 4.1 List of I/O Registers (Address Order) (4/16)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States
0008 7187h	ICU	DTC Activation Enable Register 135	DTCER135	8	8	2 ICLK
0008 7188h	ICU	DTC Activation Enable Register 136	DTCER136	8	8	2 ICLK
0008 7189h	ICU	DTC Activation Enable Register 137	DTCER137	8	8	2 ICLK
0008 718Ah	ICU	DTC Activation Enable Register 138	DTCER138	8	8	2 ICLK
0008 718Bh	ICU	DTC Activation Enable Register 139	DTCER139	8	8	2 ICLK
0008 718Ch	ICU	DTC Activation Enable Register 140	DTCER140	8	8	2 ICLK
0008 718Dh	ICU	DTC Activation Enable Register 141	DTCER141	8	8	2 ICLK
0008 71DBh	ICU	DTC Activation Enable Register 219	DTCER219	8	8	2 ICLK
0008 71DCh	ICU	DTC Activation Enable Register 220	DTCER220	8	8	2 ICLK
0008 71DFh	ICU	DTC Activation Enable Register 223	DTCER223	8	8	2 ICLK
0008 71E0h	ICU	DTC Activation Enable Register 224	DTCER224	8	8	2 ICLK
0008 71EFh	ICU	DTC Activation Enable Register 239	DTCER239	8	8	2 ICLK
0008 71F0h	ICU	DTC Activation Enable Register 240	DTCER240	8	8	2 ICLK
0008 71F7h	ICU	DTC Activation Enable Register 247	DTCER247	8	8	2 ICLK
0008 71F8h	ICU	DTC Activation Enable Register 248	DTCER248	8	8	2 ICLK
0008 7202h	ICU	Interrupt Request Enable Register 02	IER02	8	8	2 ICLK
0008 7203h	ICU	Interrupt Request Enable Register 03	IER03	8	8	2 ICLK
0008 7204h	ICU	Interrupt Request Enable Register 04	IER04	8	8	2 ICLK
0008 7205h	ICU	Interrupt Request Enable Register 05	IER05	8	8	2 ICLK
0008 7207h	ICU	Interrupt Request Enable Register 07	IER07	8	8	2 ICLK
0008 7208h	ICU	Interrupt Request Enable Register 08	IER08	8	8	2 ICLK
0008 720Bh	ICU	Interrupt Request Enable Register 0B	IER0B	8	8	2 ICLK
0008 720Ch	ICU	Interrupt Request Enable Register 0C	IER0C	8	8	2 ICLK
0008 720Dh	ICU	Interrupt Request Enable Register 0D	IER0D	8	8	2 ICLK
0008 720Eh	ICU	Interrupt Request Enable Register 0E	IER0E	8	8	2 ICLK
0008 720Fh	ICU	Interrupt Request Enable Register 0F	IER0F	8	8	2 ICLK
0008 7210h	ICU	Interrupt Request Enable Register 10	IER10	8	8	2 ICLK
0008 7211h	ICU	Interrupt Request Enable Register 11	IER11	8	8	2 ICLK
0008 7215h	ICU	Interrupt Request Enable Register 15	IER15	8	8	2 ICLK
0008 721Bh	ICU	Interrupt Request Enable Register 1B	IER1B	8	8	2 ICLK
0008 721Ch	ICU	Interrupt Request Enable Register 1C	IER1C	8	8	2 ICLK
0008 721Dh	ICU	Interrupt Request Enable Register 1D	IER1D	8	8	2 ICLK
0008 721Eh	ICU	Interrupt Request Enable Register 1E	IER1E	8	8	2 ICLK
0008 721Fh	ICU	Interrupt Request Enable Register 1F	IER1F	8	8	2 ICLK
0008 72E0h	ICU	Software Interrupt Activation Register	SWINTR	8	8	2 ICLK
0008 72F0h	ICU	Fast Interrupt Set Register	FIR	16	16	2 ICLK
0008 7300h	ICU	Interrupt Source Priority Register 000	IPR000	8	8	2 ICLK
0008 7303h	ICU	Interrupt Source Priority Register 003	IPR003	8	8	2 ICLK
0008 7304h	ICU	Interrupt Source Priority Register 004	IPR004	8	8	2 ICLK
0008 7305h	ICU	Interrupt Source Priority Register 005	IPR005	8	8	2 ICLK
0008 7320h	ICU	Interrupt Source Priority Register 032	IPR032	8	8	2 ICLK
0008 7321h	ICU	Interrupt Source Priority Register 033	IPR033	8	8	2 ICLK
0008 7322h	ICU	Interrupt Source Priority Register 034	IPR034	8	8	2 ICLK
0008 7324h	ICU	Interrupt Source Priority Register 036	IPR036	8	8	2 ICLK
0008 7325h	ICU	Interrupt Source Priority Register 037	IPR037	8	8	2 ICLK
0008 7326h	ICU	Interrupt Source Priority Register 038	IPR038	8	8	2 ICLK
0008 732Ch	ICU	Interrupt Source Priority Register 044	IPR044	8	8	2 ICLK
0008 7339h	ICU	Interrupt Source Priority Register 057	IPR057	8	8	2 ICLK
0008 733Fh	ICU	Interrupt Source Priority Register 063	IPR063	8	8	2 ICLK
0008 7340h	ICU	Interrupt Source Priority Register 064	IPR064	8	8	2 ICLK
0008 7341h	ICU	Interrupt Source Priority Register 065	IPR065	8	8	2 ICLK
0008 7342h	ICU	Interrupt Source Priority Register 066	IPR066	8	8	2 ICLK

Table 4.1 List of I/O Registers (Address Order) (9/16)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States
0008 88A2h	MTU5	Timer General Register W	TGRW	16	16	2 or 3 PCLKB
0008 88A4h	MTU5	Timer Control Register W	TCRW	8	8	2 or 3 PCLKB
0008 88A6h	MTU5	Timer I/O Control Register W	TIORW	8	8	2 or 3 PCLKB
0008 88B2h	MTU5	Timer Interrupt Enable Register	TIER	8	8	2 or 3 PCLKB
0008 88B4h	MTU5	Timer Start Register	TSTR	8	8	2 or 3 PCLKB
0008 88B6h	MTU5	Timer Compare Match Clear Register	TCNTCMPCLR	8	8	2 or 3 PCLKB
0008 8900h	POE	Input Level Control/Status Register 1	ICSR1	16	8, 16	2 or 3 PCLKB
0008 8902h	POE	Output Level Control/Status Register 1	OCSR1	16	8, 16	2 or 3 PCLKB
0008 8908h	POE	Input Level Control/Status Register 2	ICSR2	16	8, 16	2 or 3 PCLKB
0008 890Ah	POE	Software Port Output Enable Register	SPOER	8	8	2 or 3 PCLKB
0008 890Bh	POE	Port Output Enable Control Register 1	POECR1	8	8	2 or 3 PCLKB
0008 890Ch	POE	Port Output Enable Control Register 2	POECR2	8	8	2 or 3 PCLKB
0008 890Eh	POE	Input Level Control/Status Register 3	ICSR3	16	8, 16	2 or 3 PCLKB
0008 9000h	S12AD	A/D Control Register	ADCSR	16	16	2 or 3 PCLKB
0008 9004h	S12AD	A/D Channel Select Register A	ADANSA	16	16	2 or 3 PCLKB
0008 9008h	S12AD	A/D-Converted Value Addition Mode Select Register	ADADS	16	16	2 or 3 PCLKB
0008 900Ch	S12AD	A/D-Converted Value Addition Count Select Register	ADADC	8	8	2 or 3 PCLKB
0008 900Eh	S12AD	A/D Control Extended Register	ADCER	16	16	2 or 3 PCLKB
0008 9010h	S12AD	A/D Start Trigger Select Register	ADSTRGR	16	16	2 or 3 PCLKB
0008 9012h	S12AD	A/D Converted Extended Input Control Register	ADEXICR	16	16	2 or 3 PCLKB
0008 9014h	S12AD	A/D Channel Select Register B	ADANSB	16	16	2 or 3 PCLKB
0008 9018h	S12AD	A/D Data Duplication Register	ADDBLDR	16	16	2 or 3 PCLKB
0008 901Ah	S12AD	A/D Temperature Sensor Data Register	ADTSDR	16	16	2 or 3 PCLKB
0008 901Ch	S12AD	A/D Internal Reference Voltage Data Register	ADOCDR	16	16	2 or 3 PCLKB
0008 9020h	S12AD	A/D Data Register 0	ADDR0	16	16	2 or 3 PCLKB
0008 9022h	S12AD	A/D Data Register 1	ADDR1	16	16	2 or 3 PCLKB
0008 9024h	S12AD	A/D Data Register 2	ADDR2	16	16	2 or 3 PCLKB
0008 9026h	S12AD	A/D Data Register 3	ADDR3	16	16	2 or 3 PCLKB
0008 9028h	S12AD	A/D Data Register 4	ADDR4	16	16	2 or 3 PCLKB
0008 902Ch	S12AD	A/D Data Register 6	ADDR6	16	16	2 or 3 PCLKB
0008 9030h	S12AD	A/D Data Register 8	ADDR8	16	16	2 or 3 PCLKB
0008 9032h	S12AD	A/D Data Register 9	ADDR9	16	16	2 or 3 PCLKB
0008 9034h	S12AD	A/D Data Register 10	ADDR10	16	16	2 or 3 PCLKB
0008 9036h	S12AD	A/D Data Register 11	ADDR11	16	16	2 or 3 PCLKB
0008 9038h	S12AD	A/D Data Register 12	ADDR12	16	16	2 or 3 PCLKB
0008 903Ah	S12AD	A/D Data Register 13	ADDR13	16	16	2 or 3 PCLKB
0008 903Ch	S12AD	A/D Data Register 14	ADDR14	16	16	2 or 3 PCLKB
0008 903Eh	S12AD	A/D Data Register 15	ADDR15	16	16	2 or 3 PCLKB
0008 9060h	S12AD	A/D Sampling State Register 0	ADSSTR0	8	8	2 or 3 PCLKB
0008 9061h	S12AD	A/D Sampling State Register L	ADSSTRL	8	8	2 or 3 PCLKB
0008 9070h	S12AD	A/D Sampling State Register T	ADSSTRT	8	8	2 or 3 PCLKB
0008 9071h	S12AD	A/D Sampling State Register O	ADSSTRO	8	8	2 or 3 PCLKB
0008 9073h	S12AD	A/D Sampling State Register 1	ADSSTR1	8	8	2 or 3 PCLKB
0008 9074h	S12AD	A/D Sampling State Register 2	ADSSTR2	8	8	2 or 3 PCLKB
0008 9075h	S12AD	A/D Sampling State Register 3	ADSSTR3	8	8	2 or 3 PCLKB
0008 9076h	S12AD	A/D Sampling State Register 4	ADSSTR4	8	8	2 or 3 PCLKB
0008 9078h	S12AD	A/D Sampling State Register 6	ADSSTR6	8	8	2 or 3 PCLKB
0008 A020h	SCI1	Serial Mode Register	SMR	8	8	2 or 3 PCLKB
0008 A021h	SCI1	Bit Rate Register	BRR	8	8	2 or 3 PCLKB
0008 A022h	SCI1	Serial Control Register	SCR	8	8	2 or 3 PCLKB
0008 A023h	SCI1	Transmit Data Register	TDR	8	8	2 or 3 PCLKB
0008 A024h	SCI1	Serial Status Register	SSR	8	8	2 or 3 PCLKB

Table 4.1 List of I/O Registers (Address Order) (10/16)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States
0008 A025h	SCI1	Receive Data Register	RDR	8	8	2 or 3 PCLKB
0008 A026h	SCI1	Smart Card Mode Register	SCMR	8	8	2 or 3 PCLKB
0008 A027h	SCI1	Serial Extended Mode Register	SEMR	8	8	2 or 3 PCLKB
0008 A028h	SCI1	Noise Filter Setting Register	SNFR	8	8	2 or 3 PCLKB
0008 A029h	SCI1	I^2C Mode Register 1	SIMR1	8	8	2 or 3 PCLKB
0008 A02Ah	SCI1	I^2C Mode Register 2	SIMR2	8	8	2 or 3 PCLKB
0008 A02Bh	SCI1	I^2C Mode Register 3	SIMR3	8	8	2 or 3 PCLKB
0008 A02Ch	SCI1	I^2C Status Register	SISR	8	8	2 or 3 PCLKB
0008 A02Dh	SCI1	SPI Mode Register	SPMR	8	8	2 or 3 PCLKB
0008 A0A0h	SCI5	Serial Mode Register	SMR	8	8	2 or 3 PCLKB
0008 A0A1h	SCI5	Bit Rate Register	BRR	8	8	2 or 3 PCLKB
0008 A0A2h	SCI5	Serial Control Register	SCR	8	8	2 or 3 PCLKB
0008 A0A3h	SCI5	Transmit Data Register	TDR	8	8	2 or 3 PCLKB
0008 A0A4h	SCI5	Serial Status Register	SSR	8	8	2 or 3 PCLKB
0008 A0A5h	SCI5	Receive Data Register	RDR	8	8	2 or 3 PCLKB
0008 A0A6h	SCI5	Smart Card Mode Register	SCMR	8	8	2 or 3 PCLKB
0008 A0A7h	SCI5	Serial Extended Mode Register	SEMR	8	8	2 or 3 PCLKB
0008 A0A8h	SCI5	Noise Filter Setting Register	SNFR	8	8	2 or 3 PCLKB
0008 A0A9h	SCI5	I^2C Mode Register 1	SIMR1	8	8	2 or 3 PCLKB
0008 A0AAh	SCI5	I^2C Mode Register 2	SIMR2	8	8	2 or 3 PCLKB
0008 A0ABh	SCI5	I^2C Mode Register 3	SIMR3	8	8	2 or 3 PCLKB
0008 A0ACh	SCI5	I^2C Status Register	SISR	8	8	2 or 3 PCLKB
0008 A0ADh	SCI5	SPI Mode Register	SPMR	8	8	2 or 3 PCLKB
0008 B000h	CAC	CAC Control Register 0	CACR0	8	8	2 or 3 PCLKB
0008 B001h	CAC	CAC Control Register 1	CACR1	8	8	2 or 3 PCLKB
0008 B002h	CAC	CAC Control Register 2	CACR2	8	8	2 or 3 PCLKB
0008 B003h	CAC	CAC Interrupt Request Enable Register	CAICR	8	8	2 or 3 PCLKB
0008 B004h	CAC	CAC Status Register	CASTR	8	8	2 or 3 PCLKB
0008 B006h	CAC	CAC Upper-Limit Value Setting Register	CAULVR	16	16	2 or 3 PCLKB
0008 B008h	CAC	CAC Lower-Limit Value Setting Register	CALLVR	16	16	2 or 3 PCLKB
0008 B00Ah	CAC	CAC Counter Buffer Register	CACNTBR	16	16	2 or 3 PCLKB
0008 B080h	DOC	DOC Control Register	DOCR	8	8	2 or 3 PCLKB
0008 B082h	DOC	DOC Data Input Register	DODIR	16	16	2 or 3 PCLKB
0008 B084h	DOC	DOC Data Setting Register	DODSR	16	16	2 or 3 PCLKB
0008 B100h	ELC	Event Link Control Register	ELCR	8	8	2 or 3 PCLKB
0008 B102h	ELC	Event Link Setting Register 1	ELSR1	8	8	2 or 3 PCLKB
0008 B103h	ELC	Event Link Setting Register 2	ELSR2	8	8	2 or 3 PCLKB
0008 B104h	ELC	Event Link Setting Register 3	ELSR3	8	8	2 or 3 PCLKB
0008 B105h	ELC	Event Link Setting Register 4	ELSR4	8	8	2 or 3 PCLKB
0008 B108h	ELC	Event Link Setting Register 7	ELSR7	8	8	2 or 3 PCLKB
0008 B110h	ELC	Event Link Setting Register 15	ELSR15	8	8	2 or 3 PCLKB
0008 B111h	ELC	Event Link Setting Register 16	ELSR16	8	8	2 or 3 PCLKB
0008 B113h	ELC	Event Link Setting Register 18	ELSR18	8	8	2 or 3 PCLKB
0008 B115h	ELC	Event Link Setting Register 20	ELSR20	8	8	2 or 3 PCLKB
0008 B117h	ELC	Event Link Setting Register 22	ELSR22	8	8	2 or 3 PCLKB
0008 B119h	ELC	Event Link Setting Register 24	ELSR24	8	8	2 or 3 PCLKB
0008 B11Ah	ELC	Event Link Setting Register 25	ELSR25	8	8	2 or 3 PCLKB
0008 B11Fh	ELC	Event Link Option Setting Register A	ELOPA	8	8	2 or 3 PCLKB
0008 B120h	ELC	Event Link Option Setting Register B	ELOPB	8	8	2 or 3 PCLKB
0008 B121h	ELC	Event Link Option Setting Register C	ELOPC	8	8	2 or 3 PCLKB
0008 B123h	ELC	Port Group Setting Register 1	PGR1	8	8	2 or 3 PCLKB
0008 B125h	ELC	Port Group Control Register 1	PGC1	8	8	2 or 3 PCLKB

Table 4.1 List of I/O Registers (Address Order) (11/16)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States
0008 B127h	ELC	Port Buffer Register 1	PDBF1	8	8	2 or 3 PCLKB
0008 B129h	ELC	Event Link Port Setting Register 0	PEL0	8	8	2 or 3 PCLKB
0008 B12Ah	ELC	Event Link Port Setting Register 1	PEL1	8	8	2 or 3 PCLKB
0008 B12Dh	ELC	Event Link Software Event Generation Register	ELSEGR	8	8	2 or 3 PCLKB
0008 B300h	SCI12	Serial Mode Register	SMR	8	8	2 or 3 PCLKB
0008 B301h	SCI12	Bit Rate Register	BRR	8	8	2 or 3 PCLKB
0008 B302h	SCI12	Serial Control Register	SCR	8	8	2 or 3 PCLKB
0008 B303h	SCI12	Transmit Data Register	TDR	8	8	2 or 3 PCLKB
0008 B304h	SCI12	Serial Status Register	SSR	8	8	2 or 3 PCLKB
0008 B305h	SCI12	Receive Data Register	RDR	8	8	2 or 3 PCLKB
0008 B306h	SCI12	Smart Card Mode Register	SCMR	8	8	2 or 3 PCLKB
0008 B307h	SCI12	Serial Extended Mode Register	SEMR	8	8	2 or 3 PCLKB
0008 B308h	SCI12	Noise Filter Setting Register	SNFR	8	8	2 or 3 PCLKB
0008 B309h	SCI12	I^2C Mode Register 1	SIMR1	8	8	2 or 3 PCLKB
0008 B30Ah	SCI12	I^2C Mode Register 2	SIMR2	8	8	2 or 3 PCLKB
0008 B30Bh	SCI12	I^2C Mode Register 3	SIMR3	8	8	2 or 3 PCLKB
0008 B30Ch	SCI12	I^2C Status Register	SISR	8	8	2 or 3 PCLKB
0008 B30Dh	SCI12	SPI Mode Register	SPMR	8	8	2 or 3 PCLKB
0008 B320h	SCI12	Extended Serial Mode Enable Register	ESMER	8	8	2 or 3 PCLKB
0008 B321h	SCI12	Control Register 0	CR0	8	8	2 or 3 PCLKB
0008 B322h	SCI12	Control Register 1	CR1	8	8	2 or 3 PCLKB
0008 B323h	SCI12	Control Register 2	CR2	8	8	2 or 3 PCLKB
0008 B324h	SCI12	Control Register 3	CR3	8	8	2 or 3 PCLKB
0008 B325h	SCI12	Port Control Register	PCR	8	8	2 or 3 PCLKB
0008 B326h	SCI12	Interrupt Control Register	ICR	8	8	2 or 3 PCLKB
0008 B327h	SCI12	Status Register	STR	8	8	2 or 3 PCLKB
0008 B328h	SCI12	Status Clear Register	STCR	8	8	2 or 3 PCLKB
0008 B329h	SCI12	Control Field 0 Data Register	CF0DR	8	8	2 or 3 PCLKB
0008 B32Ah	SCI12	Control Field 0 Compare Enable Register	CF0CR	8	8	2 or 3 PCLKB
0008 B32Bh	SCI12	Control Field 0 Receive Data Register	CF0RR	8	8	2 or 3 PCLKB
0008 B32Ch	SCI12	Primary Control Field 1 Data Register	PCF1DR	8	8	2 or 3 PCLKB
0008 B32Dh	SCI12	Secondary Control Field 1 Data Register	SCF1DR	8	8	2 or 3 PCLKB
0008 B32Eh	SCI12	Control Field 1 Compare Enable Register	CF1CR	8	8	2 or 3 PCLKB
0008 B32Fh	SCI12	Control Field 1 Receive Data Register	CF1RR	8	8	2 or 3 PCLKB
0008 B330h	SCI12	Timer Control Register	TCR	8	8	2 or 3 PCLKB
0008 B331h	SCI12	Timer Mode Register	TMR	8	8	2 or 3 PCLKB
0008 B332h	SCI12	Timer Prescaler Register	TPRE	8	8	2 or 3 PCLKB
0008 B333h	SCI12	Timer Count Register	TCNT	8	8	2 or 3 PCLKB
0008 C000h	PORT0	Port Direction Register	PDR	8	8	2 or 3 PCLKB
0008 C001h	PORT1	Port Direction Register	PDR	8	8	2 or 3 PCLKB
0008 C002h	PORT2	Port Direction Register	PDR	8	8	2 or 3 PCLKB
0008 C003h	PORT3	Port Direction Register	PDR	8	8	2 or 3 PCLKB
0008 C004h	PORT4	Port Direction Register	PDR	8	8	2 or 3 PCLKB
0008 C005h	PORT5	Port Direction Register	PDR	8	8	2 or 3 PCLKB
0008 C00Ah	PORTA	Port Direction Register	PDR	8	8	2 or 3 PCLKB
0008 C00Bh	PORTB	Port Direction Register	PDR	8	8	2 or 3 PCLKB
0008 C00Ch	PORTC	Port Direction Register	PDR	8	8	2 or 3 PCLKB
0008 C00Eh	PORTE	Port Direction Register	PDR	8	8	2 or 3 PCLKB
0008 C012h	PORTJ	Port Direction Register	PDR	8	8	2 or 3 PCLKB
0008 C020h	PORT0	Port Output Data Register	PODR	8	8	2 or 3 PCLKB
0008 C021h	PORT1	Port Output Data Register	PODR	8	8	2 or 3 PCLKB
0008 C022h	PORT2	Port Output Data Register	PODR	8	8	2 or 3 PCLKB

Table 5.12 DC Characteristics (10)

Conditions: 1.8 V ≤ VCC = VCC_USB ≤ 3.6 V, 1.8 V ≤ AVSS0 ≤ 3.6 V, VSS = AVSS0 = VSS_USB = 0 V, T_a = –40 to +105°C

Item		Symbol	Min.	Typ.*7	Max.	Unit	Test Conditions
Analog power supply current	During A/D conversion (at high-speed conversion)	I_{AVCC}	—	0.7	1.2	mA	
	Waiting for A/D (all units)		—	—	0.3	µA	
	During D/A conversion (per channel)*5		—	—	1.5	mA	
Reference power supply current	During A/D conversion (at high-speed conversion)	I_{REFH0}	—	25	52	µA	
	Waiting for A/D conversion (all units)		—	—	60	nA	
Temperature sensor*6		I_{TEMP}	—	75	—	µA	
LDV1, 2	Per channel	I_{LVD}	—	0.15	—	µA	
USB operating current	During USB communication operation under the following settings and conditions • Host controller operation is set to full-speed mode Bulk OUT transfer (64 bytes) × 1, bulk IN transfer (64 bytes) × 1 • Connect peripheral devices via a 1-meter USB cable from the USB port.	I_{USBH}*2	—	4.3 (VCC) 0.9 (VCC_USB) *4	—	mA	
	During USB communication operation under the following settings and conditions • Function controller operation is set to full-speed mode Bulk OUT transfer (64 bytes) × 1, bulk IN transfer (64 bytes) × 1 • Connect the host device via a 1-meter USB cable from the USB port.	I_{USBF}*2	—	3.6 (VCC) 1.1 (VCC_USB) *4	—	mA	
	During suspended state under the following setting and conditions • Function controller operation is set to full-speed mode (pull up the USB0_DP pin) • Software standby mode • Connect the host device via a 1-meter USB cable from the USB port.	I_{SUSP}*3	—	0.35 (VCC) 170 (VCC_USB) *4	—	µA	

Note 1. The reference power supply current is included in the power supply current value for D/A conversion.
Note 2. Current consumed only by the USB module.
Note 3. Includes the current supplied from the pull-up resistor of the USB0_DP pin to the pull-down resistor of the host device, in addition to the current consumed by this MCU during the suspended state.
Note 4. When VCC = VCC_USB = 3.3 V.
Note 5. The value of the current flowing to VCC.
Note 6. Current consumed by the power supply (VCC).
Note 7. When VCC = AVCC0 = VCC_USB = 3.3 V.

Table 5.13 DC Characteristics (11)

Conditions: 1.8 V ≤ VCC = VCC_USB ≤ 3.6 V, 1.8 V ≤ AVSS0 ≤ 3.6 V, VSS = AVSS0 = VSS_USB = 0 V, T_a = –40 to +105°C

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
RAM standby voltage	V_{RAM}	1.8	—	—	V	

5.2.1 Standard I/O Pin Output Characteristics (1)

Figure 5.12 to Figure 5.15 show the characteristics of general ports (except for the RIIC output pin, ports P40 to P44, P46, ports PJ6, PJ7)

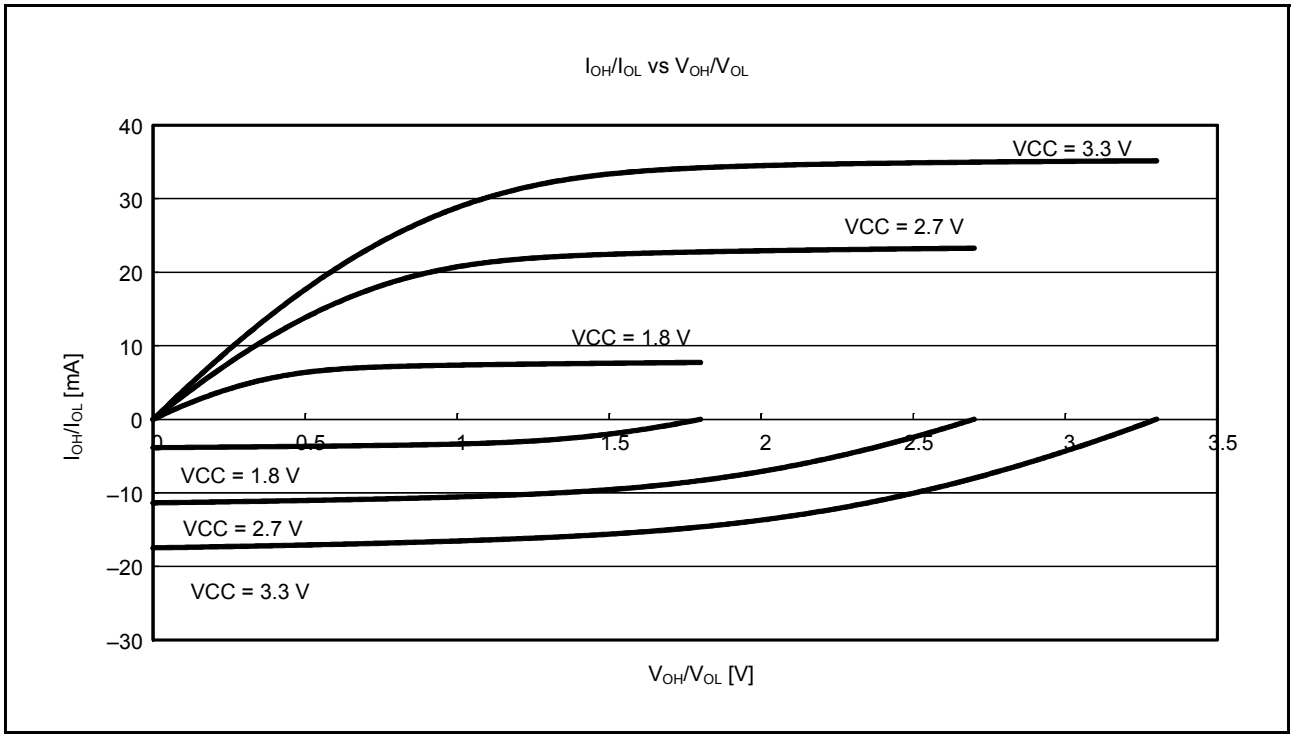


Figure 5.12 V_{OH}/V_{OL} and I_{OH}/I_{OL} Voltage Characteristics of General Ports (Except for the RIIC Output Pin, Ports P40 to P44, P46, Ports PJ6, PJ7) at T_a = 25°C (Reference Data)

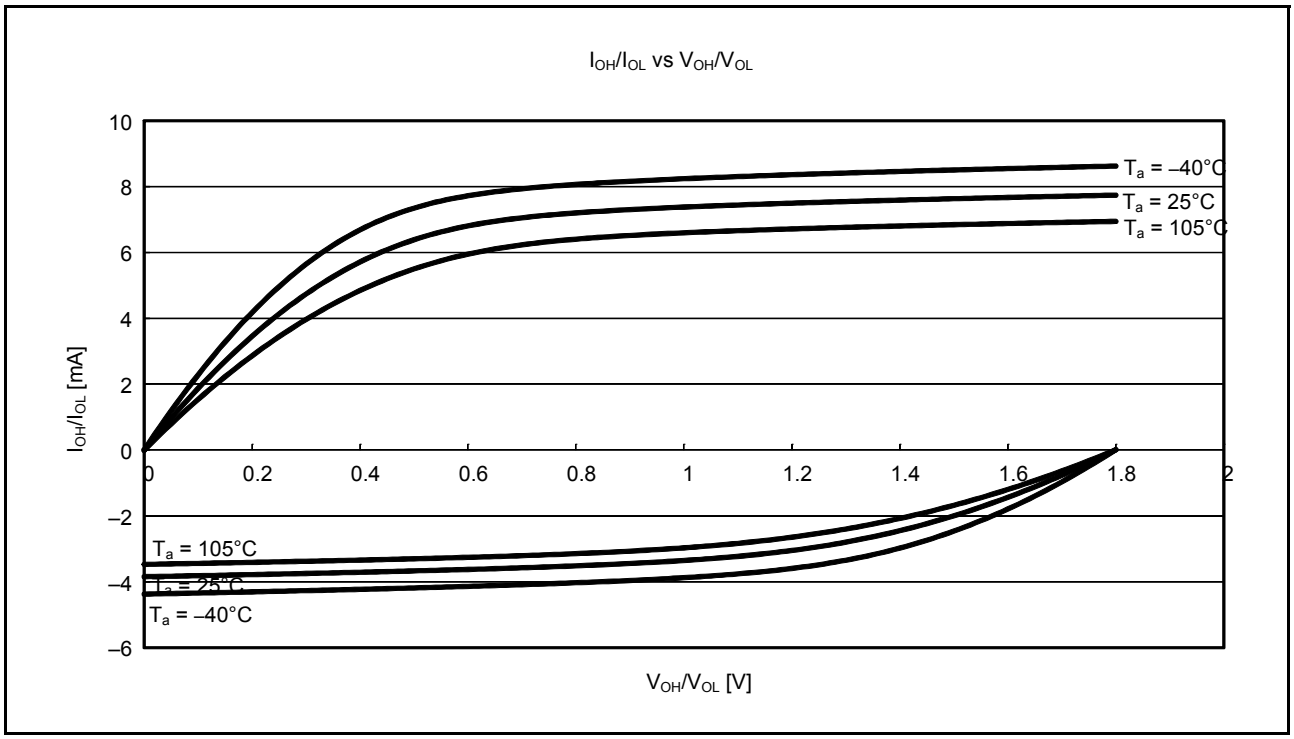


Figure 5.13 V_{OH}/V_{OL} and I_{OH}/I_{OL} Temperature Characteristics of General Ports (Except for the RIIC Output Pin, Ports P40 to P44, P46, Ports PJ6, PJ7) at VCC = 1.8 V (Reference Data)

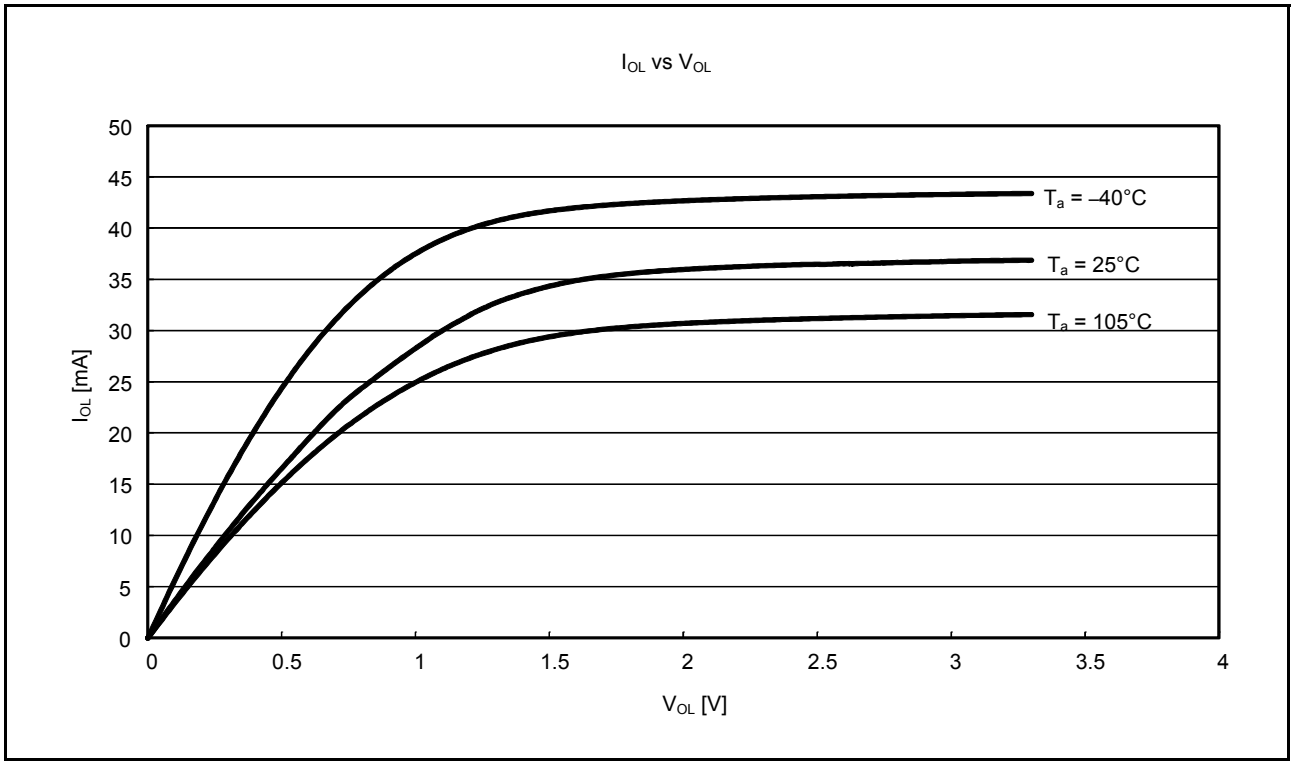


Figure 5.18 V_{OL} and I_{OL} Temperature Characteristics of RIIC Output Pin at VCC = 3.3 V (Reference Data)

5.3.4 Control Signal Timing

Table 5.31 Control Signal Timing

Conditions: 1.8 V ≤ VCC = VCC_USB ≤ 3.6 V, 1.8 V ≤ AVSS0 ≤ 3.6 V, VSS = AVSS0 = VSS_USB = 0 V, T_a = –40 to +105°C

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions	
NMI pulse width	t_{NMIW}	200	—	—	ns	NMI digital filter disabled (NMIFLTE.NFLTEN = 0)	t_{Pcyc} × 2 ≤ 200 ns
		t_{Pcyc} × 2*1	—	—			t_{Pcyc} × 2 > 200 ns
		200	—	—		NMI digital filter enabled (NMIFLTE.NFLTEN = 1)	t_{NMICK} × 3 ≤ 200 ns
		t_{NMICK} × 3.5*2	—	—			t_{NMICK} × 3 > 200 ns
IRQ pulse width	t_{IRQW}	200	—	—	ns	IRQ digital filter disabled (IRQFLTE0.FLTENi = 0)	t_{Pcyc} × 2 ≤ 200 ns
		t_{Pcyc} × 2*1	—	—			t_{Pcyc} × 2 > 200 ns
		200	—	—		IRQ digital filter enabled (IRQFLTE0.FLTENi = 1)	t_{IRQCK} × 3 ≤ 200 ns
		t_{IRQCK} × 3.5*3	—	—			t_{IRQCK} × 3 > 200 ns

Note: • 200 ns minimum in software standby mode.
Note 1. t_{Pcyc} indicates the cycle of PCLKB.
Note 2. t_{NMICK} indicates the cycle of the NMI digital filter sampling clock.
Note 3. t_{IRQCK} indicates the cycle of the IRQi digital filter sampling clock (i = 0 to 7).

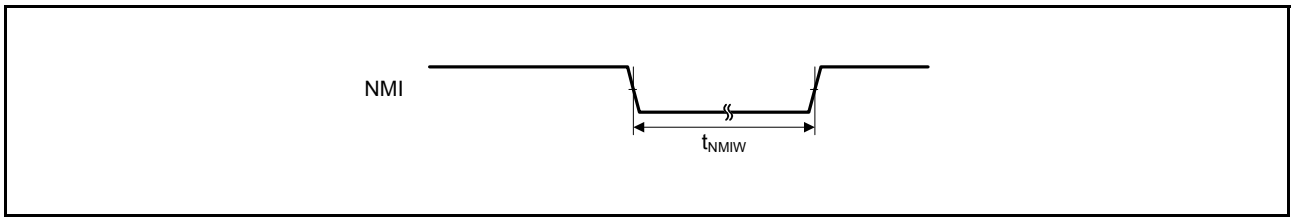


Figure 5.36 NMI Interrupt Input Timing

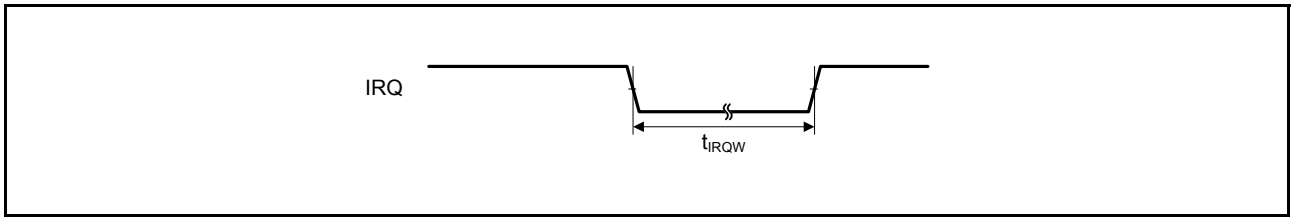


Figure 5.37 IRQ Interrupt Input Timing

Table 5.35 Timing of On-Chip Peripheral Modules (4)

Conditions: 2.7 V ≤ VCC = VCC_USB ≤ 3.6 V, 2.7 V ≤ AVSS0 ≤ 3.6 V, VSS = AVSS0 = VSS_USB = 0 V, fPCLKB ≤ 32 MHz, T_a = –40 to +105°C

Item		Symbol	Min.*1	Max.	Unit	Test Conditions
RIIC (Standard mode, SMBus)	SCL0 input cycle time	t_{SCL}	6 (12) × t_{IICcyc} + 1300	—	ns	Figure 5.53
	SCL0 input high pulse width	t_{SCLH}	3 (6) × t_{IICcyc} + 300	—	ns	
	SCL0 input low pulse width	t_{SCLL}	3 (6) × t_{IICcyc} + 300	—	ns	
	SCL0, SDA0 input rise time	t_{Sr}	—	1000	ns	
	SCL0, SDA0 input fall time	t_{Sf}	—	300	ns	
	SCL0, SDA0 input spike pulse removal time	t_{SP}	0	1 (4) × t_{IICcyc}	ns	
	SDA0 input bus free time	t_{BUF}	3 (6) × t_{IICcyc} + 300	—	ns	
	START condition input hold time	t_{STAH}	t_{IICcyc} + 300	—	ns	
	Repeated START condition input setup time	t_{STAS}	1000	—	ns	
	STOP condition input setup time	t_{STOS}	1000	—	ns	
	Data input setup time	t_{SDAS}	t_{IICcyc} + 50	—	ns	
	Data input hold time	t_{SDAH}	0	—	ns	
	SCL0, SDA0 capacitive load	C_b	—	400	pF	
RIIC (Fast mode)	SCL0 input cycle time	t_{SCL}	6 (12) × t_{IICcyc} + 600	—	ns	Figure 5.53
	SCL0 input high pulse width	t_{SCLH}	3 (6) × t_{IICcyc} + 300	—	ns	
	SCL0 input low pulse width	t_{SCLL}	3 (6) × t_{IICcyc} + 300	—	ns	
	SCL0, SDA0 input rise time	t_{Sr}	—*2	300	ns	
	SCL0, SDA0 input fall time	t_{Sf}	—*2	300	ns	
	SCL0, SDA0 input spike pulse removal time	t_{SP}	0	1 (4) × t_{IICcyc}	ns	
	SDA0 input bus free time	t_{BUF}	3 (6) × t_{IICcyc} + 300	—	ns	
	START condition input hold time	t_{STAH}	t_{IICcyc} + 300	—	ns	
	Repeated START condition input setup time	t_{STAS}	300	—	ns	
	STOP condition input setup time	t_{STOS}	300	—	ns	
	Data input setup time	t_{SDAS}	t_{IICcyc} + 50	—	ns	
	Data input hold time	t_{SDAH}	0	—	ns	
	SCL0, SDA0 capacitive load	C_b	—	400	pF	

Note: • t_{IICcyc}: RIIC internal reference count clock (IICφ) cycle

Note 1. The value in parentheses is used when the ICMR3.NF[1:0] bits are set to 11b while a digital filter is enabled with the ICFER.NFE bit = 1.

Note 2. The minimum tsr and tsf specifications for fast mode are not set.

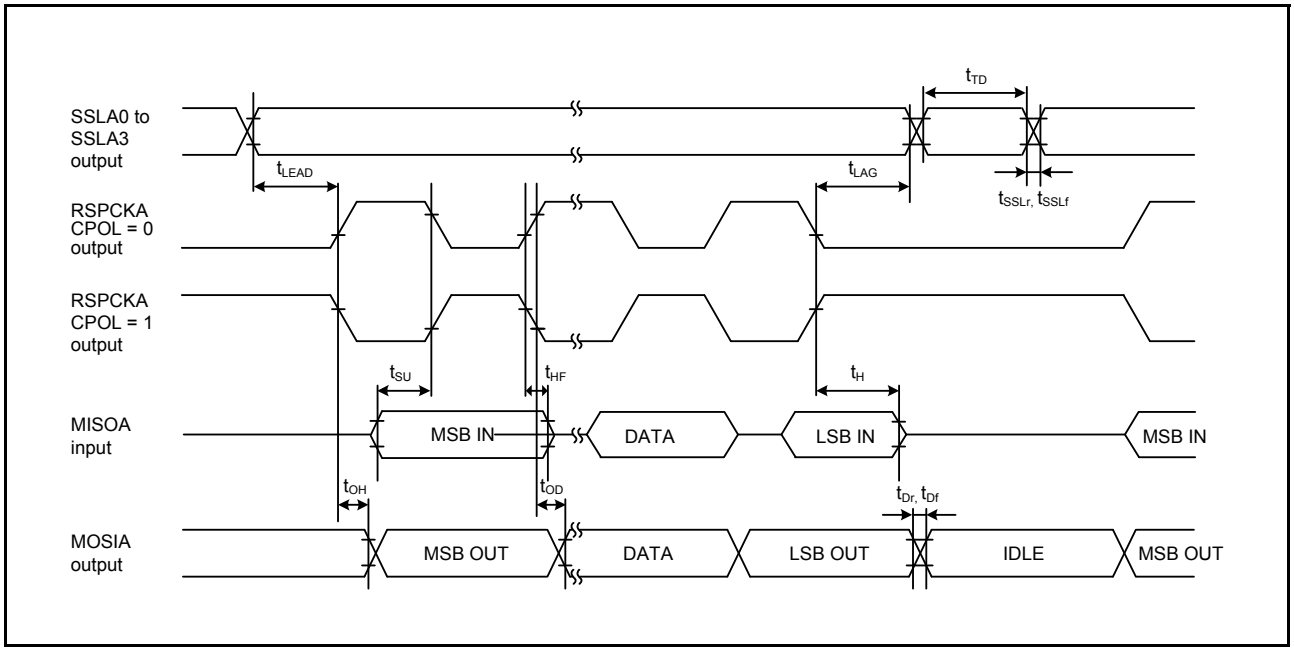


Figure 5.50 RSPI Timing (Master, CPHA = 1) (Bit Rate: PCLKB Set to Divided by 2)

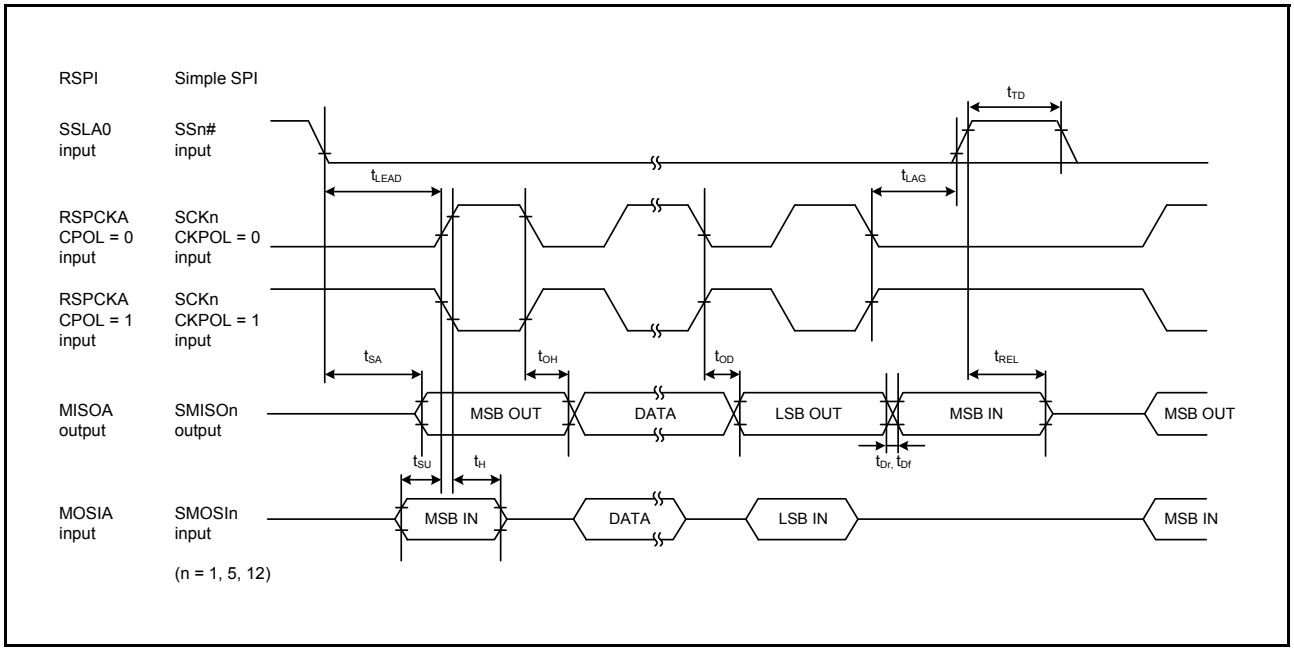


Figure 5.51 RSPI Timing (Slave, CPHA = 0) and Simple SPI Timing (Slave, CKPH = 1)

5.5 A/D Conversion Characteristics

Table 5.38 A/D Conversion Characteristics (1)

Conditions: 2.7 V ≤ VCC = VCC_USB ≤ 3.6 V, 2.7 V ≤ AVCC0 ≤ 3.6 V, 2.7 V ≤ VREFH0 ≤ AVCC0,
VSS = AVSS0 = VREFL0 = VSS_USB = 0 V, T_a = –40 to +105°C

Item		Min.	Typ.	Max.	Unit	Test Conditions
Frequency		4	—	32	MHz	
Resolution		—	—	12	Bit	
Conversion time*1 (Operation at PCLKD = 32 MHz)	Permissible signal source impedance (Max.) = 0.3 kΩ	1.031 (0.313)*2	—	—	µs	High-precision channel ADCSR.ADHSC bit = 1 ADSSTRn.SST[7:0] bits = 09h
		1.375 (0.641)*2	—	—		Normal-precision channel ADCSR.ADHSC bit = 1 ADSSTRn.SST[7:0] bits = 14h
Analog input effective range		0	—	VREFH0	V	
Offset error		—	±0.5	±4.5	LSB	High-precision channel PJ6PFS.ASEL bit = 1 PJ7PFS.ASEL bit = 1
				±6.0	LSB	Other than above
Full-scale error		—	±0.75	±4.5	LSB	High-precision channel PJ6PFS.ASEL bit = 1 PJ7PFS.ASEL bit = 1
				±6.0	LSB	Other than above
Quantization error		—	±0.5	—	LSB	
Absolute accuracy		—	±1.25	±5.0	LSB	High-precision channel PJ6PFS.ASEL bit = 1 PJ7PFS.ASEL bit = 1
				±8.0	LSB	Other than above
DNL differential nonlinearity error		—	±1.0	—	LSB	
INL integral nonlinearity error		—	±1.0	±3.0	LSB	

Note: • The characteristics apply when no pin functions other than A/D converter input are used. Absolute accuracy includes quantization errors. Offset error, full-scale error, DNL differential nonlinearity error, and INL integral nonlinearity error do not include quantization errors.

Note 1. The conversion time is the sum of the sampling time and the comparison time. As the test conditions, the number of sampling states is indicated.

Note 2. The value in parentheses indicates the sampling time.

5.10 ROM (Flash Memory for Code Storage) Characteristics

Table 5.48 ROM (Flash Memory for Code Storage) Characteristics (1)

Item		Symbol	Min.	Typ.	Max.	Unit	Conditions
Reprogramming/erasure cycle*1		N_{PEC}	1000	—	—	Times	
Data hold time	After 1000 times of N_{PEC}	t_{DRP}	20*2, *3	—	—	Year	T_a = +85°C

Note 1. Definition of reprogram/erase cycle: The reprogram/erase cycle is the number of erasing for each block. When the reprogram/erase cycle is n times (n = 1000), erasing can be performed n times for each block. For instance, when 4-byte programming is performed 256 times for different addresses in 1-Kbyte block and then the entire block is erased, the reprogram/erase cycle is counted as one. However, programming the same address for several times as one erasing is not enabled (overwriting is prohibited).
Note 2. Characteristic when using the flash memory programmer and the self-programming library provided from Renesas Electronics.
Note 3. This result is obtained from reliability testing.

Table 5.49 ROM (Flash Memory for Code Storage) Characteristics (2)

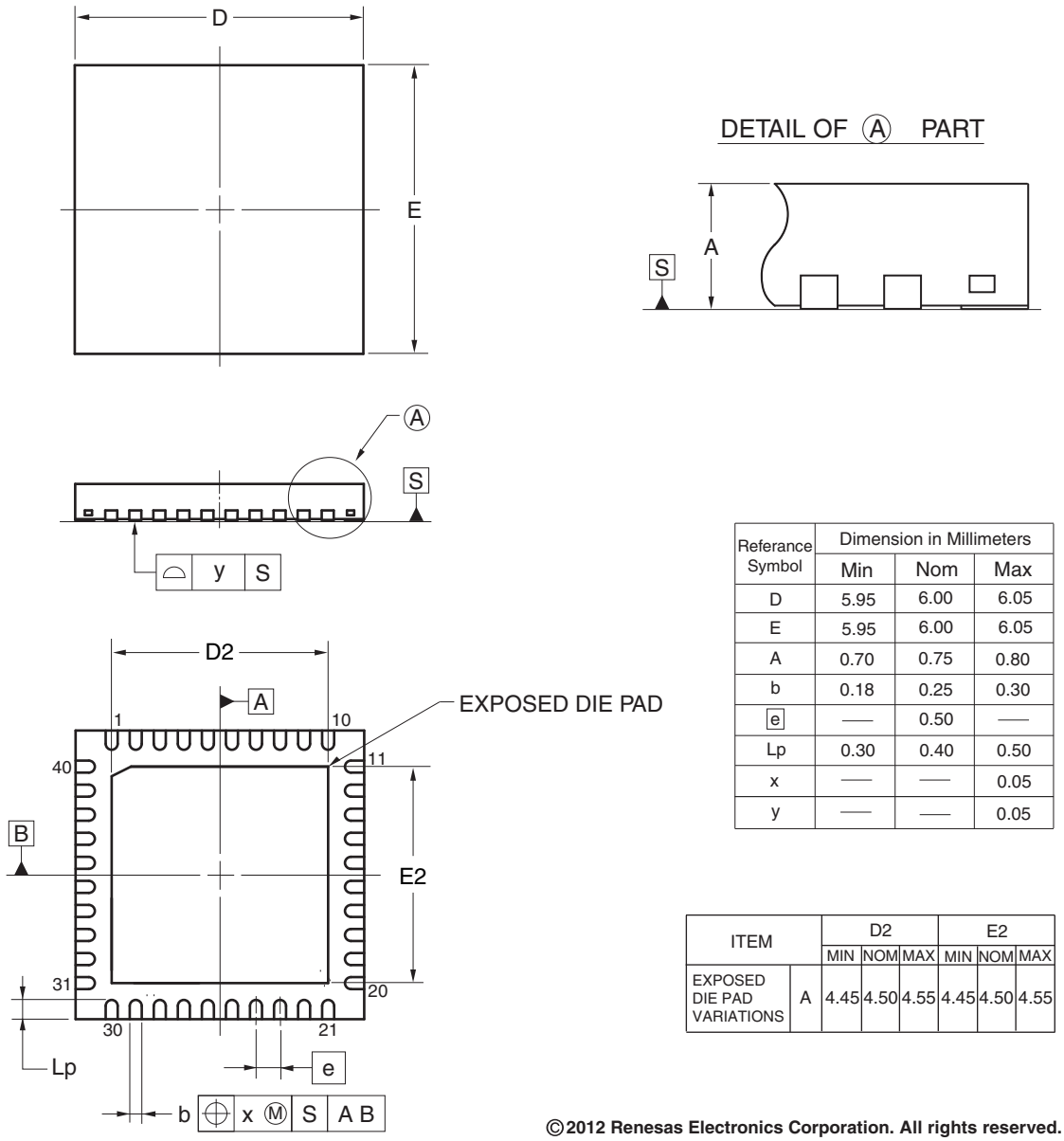
High-speed operating mode Conditions: 2.7 V ≤ VCC ≤ 3.6 V, 2.7 V ≤ AVSS0 ≤ 3.6 V, VSS = AVSS0 = VSS_USB = 0 V

Temperature range for the programming/erasure operation: T_a = –40 to +105°C

Item		Symbol	FCLK = 1 MHz			FCLK = 32 MHz			Unit
			Min.	Typ.	Max.	Min.	Typ.	Max.	
Programming time	4-byte	t_{P4}	—	103	931	—	52	489	µs
Erasure time	1-Kbyte	t_{E1K}	—	8.23	267	—	5.48	214	ms
	256-Kbyte	t_{E256K}	—	407	925	—	39	457	ms
Blank check time	4-byte	t_{BC4}	—	—	48	—	—	15.9	µs
	1-Kbyte	t_{BC1K}	—	—	1.58	—	—	0.127	ms
Erase operation forcible stop time		t_{SED}	—	—	21.6	—	—	12.8	µs
Start-up area switching setting time		t_{SAS}	—	12.6	543	—	6.16	432	ms
Access window time		t_{AWS}	—	12.6	543	—	6.16	432	ms
ROM mode transition wait time 1		t_{DIS}	2	—	—	2	—	—	µs
ROM mode transition wait time 2		t_{MS}	5	—	—	5	—	—	µs

Note: • Does not include the time until each operation of the flash memory is started after instructions are executed by software.
Note: • The lower-limit frequency of FCLK is 1 MHz during programming or erasing of the flash memory. When using FCLK at below 4 MHz, the frequency can be set to 1 MHz, 2 MHz, or 3 MHz. A non-integer frequency such as 1.5 MHz cannot be set.
Note: • The frequency accuracy of FCLK should be ±3.5%. Confirm the frequency accuracy of the clock source.

JEITA Package Code	RENESAS Code	Previous Code	MASS (TYP.) [g]
P-HWQFN40-6x6-0.50	PWQN0040KC-A	P40K8-50-4B4-4	0.09



Referance Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	5.95	6.00	6.05
E	5.95	6.00	6.05
A	0.70	0.75	0.80
b	0.18	0.25	0.30
e	—	0.50	—
Lp	0.30	0.40	0.50
x	—	—	0.05
y	—	—	0.05

ITEM		D2			E2		
		MIN	NOM	MAX	MIN	NOM	MAX
EXPOSED DIE PAD VARIATIONS	A	4.45	4.50	4.55	4.45	4.50	4.55

Figure F 40-Pin HWQFN (PWQN0040KC-A)

Classifications

- Items with Technical Update document number: Changes according to the corresponding issued Technical Update
- Items without Technical Update document number: Minor changes that do not require Technical Update to be issued

Rev.	Date	Description		Classification
		Page	Summary	
1.30	May 31, 2016	1. Overview		
		18 to 26	Table 1.5 to 1.9 Note 2 regarding I/O power source is AVCC0 for the ports (P4, PJ6, and PJ7), added	
		5. Electrical Characteristics		
		49	Table 5.1 Absolute Maximum Ratings, Analog power supply voltage added	
		49	Table 5.2 Recommended Operating Conditions, VREFH0 / VREFL0 added	
		58	Figure 5.4 Voltage Dependency in High-Speed Operating Mode (Reference Data) added	
		59	Figure 5.5 Voltage Dependency in Middle-Speed Operating Mode (Reference Data) added	
		59	Figure 5.6 Voltage Dependency in Low-Speed Operating Mode (Reference Data) added	
		60	Table 5.9 DC Characteristics (7), Increment for IWDT operation added	
		62	Table 5.10 DC Characteristics (8), Increment for IWDT operation added	
		62	Figure 5.9 Voltage Dependency in Software Standby Mode (Reference Data) added	
		63	Figure 5.10 Temperature Dependency in Software Standby Mode (Reference Data) added	
		63	Table 5.11 DC Characteristics (9) added	TN-RX*-A134A/E
		64	Table 5.12 DC Characteristics (10), LDV1, 2 added	
		66, 67	Table 5.18 Permissible Output Currents is divided into D version and G version	TN-RX*-A134A/E
		110	Table 5.49 ROM (Flash Memory for Code Storage) Characteristics (2), Erasure time - 256-Kbyte added	TN-RX*-A132A/E
		111	Table 5.50 ROM (Flash Memory for Code Storage) Characteristics (3), Temperature range for the programming/erasure operation changed and Erasure time - 256-Kbyte added	TN-RX*-A132A/E
		112	Table 5.52 E2 DataFlash Characteristics (2), Low speed FCLK changed and Erasure time - 8-Kbyte added	TN-RX*-A132A/E
		112	Table 5.53 E2 DataFlash Characteristics (3), Temperature range for the programming/erasure operation changed, Low speed FCLK changed and Erasure time - 8-Kbyte added	TN-RX*-A132A/E
		113, 114	5.12 Usage Notes added	